



Integrated Device Technology, Inc.

HIGH-SPEED CMOS UP/DOWN BINARY COUNTER

IDT54/74AHCT191

FEATURES:

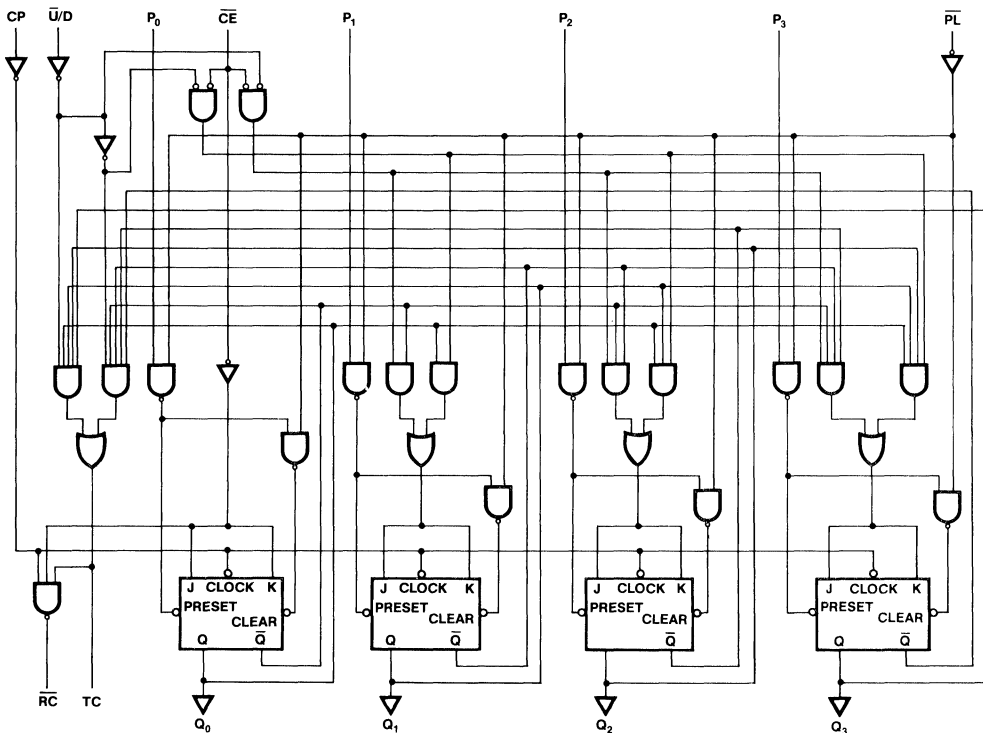
- Equivalent to ALS speeds and output drive over full temperature and voltage supply extremes
- $I_{OL} = 14\text{mA}$ over full military temperature range
- CMOS power levels ($5\mu\text{W}$ typ. static)
- Both CMOS and TTL output compatible
- Substantially lower input current levels than ALS (5μ max.)
- 100% product assurance screening to MIL-STD-883, Class B is available
- JEDEC standard pinout for DIP and LCC

DESCRIPTION:

The IDT54/74AHCT191 is a reversible modulo-16 binary counter, featuring synchronous counting and asynchronous presetting, built using advanced CEMOS™, a dual metal CMOS technology.

The preset feature allows the IDT54/74AHCT191 to be used in programmable dividers. The Count Enable input, the Terminal Count output and the Ripple Clock output make possible a variety of methods of implementing multistage counters. In the counting modes, state changes are initiated by the rising edge of the clock.

FUNCTIONAL BLOCK DIAGRAM



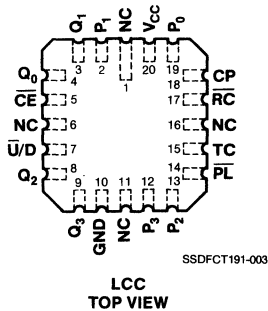
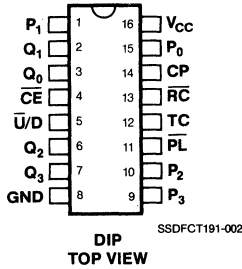
SSDFCT191-001

CEMOS is a trademark of Integrated Device Technology, Inc.

MILITARY AND COMMERCIAL TEMPERATURE RANGES

JULY 1986

PIN CONFIGURATIONS



ABSOLUTE MAXIMUM RATING⁽¹⁾

SYMBOL	RATING	COMMERCIAL	MILITARY	UNIT
V _{TERM}	Terminal Voltage with Respect to GND	-0.5 to +7.0	-0.5 to +7.0	V
T _A	Operation Temperature	0 to +70	-55 to +125	°C
T _{BIAS}	Temperature Under Bias	-55 to +125	-65 to +135	°C
T _{STG}	Storage Temperature	-55 to +125	-65 to +155	°C
I _{OUT}	DC Output Current	120	120	mA

NOTE:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

T_A = 0°C to +70°C V_{CC} = 5.0V ± 5% Min. = 4.75V Max. = 5.25V (Commercial)
 T_A = -55°C to +125°C V_{CC} = 5.0V ± 10% Min. = 4.50V Max. = 5.50V (Military)
 V_{LC} = 0.2V
 V_{HC} = V_{CC} - 0.2V

SYMBOL	PARAMETER	TEST CONDITIONS ⁽¹⁾	MIN.	TYP. ⁽²⁾	MAX.	UNIT	
V _{IH}	Input HIGH Level	Guaranteed Logic High Level	2.0	—	—	V	
V _{IL}	Input LOW Level	Guaranteed Logic Low Level	—	—	0.8	V	
I _{IH}	Input HIGH Current	V _{CC} = Max., V _{IN} = V _{CC}	—	—	5	μA	
I _{IL}	Input LOW Current	V _{CC} = Max., V _{IN} = GND	—	—	-5	μA	
I _{SC}	Short Circuit Current	V _{CC} = Max. ⁽³⁾	-60	-100	—	mA	
V _{OH}	Output HIGH Voltage	V _{CC} = 3V, V _{IN} = V _{LC} or V _{HC} , I _{OH} = -32μA	V _{HC}	V _{CC}	—	V	
		V _{CC} = Min., V _{IN} = V _{IH} or V _{IL}	I _{OH} = -150μA	V _{HC}	V _{CC}		—
			I _{OH} = -1.0mA MIL.	2.4	4.3		—
V _{OL}	Output LOW Voltage	V _{CC} = 3V, V _{IN} = V _{LC} or V _{HC} , I _{OL} = 300μA	—	GND	V _{LC}	V	
		V _{CC} = Min., V _{IN} = V _{IH} or V _{IL}	I _{OL} = 300μA	—	GND		V _{LC}
			I _{OL} = 14mA MIL.	—	—		0.4
		I _{OL} = 24mA COM'L.	—	—	0.5		

NOTES:

- For conditions shown as max. or min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at V_{CC} = 5.0V, +25°C ambient and maximum loading.
- Not more than one output should be shorted at one time. Duration of the short circuit test should not exceed one second.

POWER SUPPLY CHARACTERISTICS

$V_{LC} = 0.2V; V_{HC} = V_{CC} - 0.2V$

SYMBOL	PARAMETER	TEST CONDITIONS ⁽¹⁾		MIN.	TYP. ⁽²⁾	MAX.	UNIT
I_{CCQ}	Quiescent Power Supply Current	$V_{CC} = \text{Max.}$ $V_{IN} \geq V_{HC}; V_{IN} \leq V_{LC}$ $f_{CP} = f_i = 0$		—	0.001	1.5	mA
I_{CCT}	Power Supply Current Per TTL Input HIGH	$V_{CC} = \text{Max.}$ $V_{IN} = 3.4V$ ⁽³⁾		—	0.5	1.6	mA
I_{CCD}	Dynamic Power Supply Current	$V_{CC} = \text{Max.}$ Outputs Open Count Up or Down $CE = V_{LC}$ $PL = P_0 - P_3 = V_{HC}$ $U/D = V_{HC}$ or V_{LC}	$V_{IN} \geq V_{HC}$ $V_{IN} \leq V_{LC}$	—	0.3	—	mA/ MHz
I_{CC}	Total Power Supply Current ⁽⁴⁾	$V_{CC} = \text{Max.}$ Outputs Open $f_{CP} = 1.0\text{MHz}$ 50% Duty Cycle Count Up or Down $CE = V_{LC}$ $PL = P_0 - P_3 = V_{HC}$ $U/D = V_{HC}$ or V_{LC}	$V_{IN} \geq V_{HC}$ $V_{IN} \leq V_{LC}$ (AHCT)	—	0.3	—	mA
			$V_{IN} = 3.4V$ or $V_{IN} = \text{GND}$	—	1.1	—	

NOTES:

- For conditions shown as max. or min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at $V_{CC} = 5.0V, +25^\circ\text{C}$ ambient and maximum loading.
- Not more than one output should be shorted at one time. Duration of the short circuit test should not exceed one second.
- Per TTL driven input ($V_{IN} = 3.4V$); all other inputs at V_{CC} or GND.
- $I_{CC} = I_{\text{QUIESCENT}} + I_{\text{INPUTS}} + I_{\text{DYNAMIC}}$
 $I_{CC} = I_{CCQ} + I_{CCT}D_HN_T + I_{CCD}(f_{CP} + f_iN_i)$
 I_{CCQ} = Quiescent Current
 I_{CCT} = Power Supply Current for a TTL High Input ($V_{IN} = 3.4V$)
 D_H = Duty Cycle for TTL Input High
 N_T = Number of TTL Inputs at D_H
 I_{CCD} = Dynamic Current caused by an Input Transition pair (HLH or LHL)
 f_{CP} = Count Clock or Load Clock Frequency
 f_i = P_{0-3} Input Frequency (Load)
 N_i = Number of P_{0-3} Inputs at f_i (Load)

All currents are in milliamps and all frequencies are in megahertz.

DEFINITION OF FUNCTIONAL TERMS

PIN NAMES	DESCRIPTION
\overline{CE}	Count Enable Input (Active LOW)
CP	Count Pulse Input (Active Rising Edge)
P ₀₋₃	Parallel Data Inputs
PL	Asynchronous Parallel Load Input (Active LOW)
U/D	Up/Down Count Control Input
Q ₀₋₃	Flip-Flop Outputs
RC	Ripple Clock Output (Active LOW)
TC	Terminal Clock Output (Active HIGH)

RC TRUTH TABLE

INPUTS			OUTPUT
\overline{CE}	TC ⁽¹⁾	CP	\overline{RC}
L	H		
H	X	X	H
X	L	X	H

NOTES:

- TC is generated internally.
- H = HIGH Voltage Level
L = LOW Voltage Level
X = Immaterial

TRUTH TABLES

MODE SELECT TABLE

INPUTS				MODE
PL	\overline{CE}	U/D	CP	
H	L	L	↑	Count Up
H	L	H	↑	Count Down
L	X	X	X	Preset (Asynch.)
H	H	X	X	No Change (Hold)

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

SYMBOL	PARAMETER	CONDITION	TYPICAL	COMMERCIAL		MILITARY		UNITS
				MIN..	MAX.	MIN.	MAX.	
t _{PLH} t _{PHL}	Propagation Delay CP to Q _n	C _L = 50pF R _L = 500Ω	—	3.0	18.0	3.0	22.0	ns
t _{PLH} t _{PHL}	Propagation Delay CP to TC		—	6.0	31.0	6.0	34.0	ns
t _{PLH} t _{PHL}	Propagation Delay CP to RC		—	5.0	20.0	4.0	24.0	ns
t _{PLH} t _{PHL}	Propagation Delay CE to RC		—	4.0	18.0	4.0	21.0	ns
t _{PLH} t _{PHL}	Propagation Delay U/D to RC		—	6.0	25.0	6.0	30.0	ns
t _{PLH} t _{PHL}	Propagation Delay U/D to TC		—	6.0	25.0	6.0	30.0	ns
t _{PLH} t _{PHL}	Propagation Delay P _n to Q _n		—	4.0	21.0	4.0	25.0	ns
t _{PLH} t _{PHL}	Propagation Delay PL to Q _n		—	6.0	30.0	6.0	34.0	ns
t _S (H) t _S (L)	Setup Time HIGH or LOW P _n to PL		—	20.0	—	25.0	—	ns
t _H (H) t _H (L)	Hold Time HIGH or LOW P _n to PL		—	5.0	—	5.0	—	ns
t _S (L)	Setup Time LOW CE to CP		—	20.0	—	25.0	—	ns
t _H (L)	Hold Time LOW CE to CP		—	0	—	0	—	ns
t _S (H) t _S (L)	Setup Time HIGH or LOW U/D to CP		—	20.0	—	20.0	—	ns
t _H (H) t _H (L)	Hold Time HIGH or LOW U/D to CP		—	0	—	0	—	ns
t _W (L)	PL Pulse Width LOW		—	20.0	—	25.0	—	ns
t _W (L)	CP Pulse Width LOW		—	15.0	—	20.0	—	ns
t _{REC}	Recovery Time PL to CP	—	15.0	—	20.0	—	ns	